

Welcome to **E-XFL.COM**

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	60 MIPs
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	21
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 12x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep16gs502t-e-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

REGISTER 3-2: CORCON: CORE CONTROL REGISTER (CONTINUED)

bit 2 SFA: Stack Frame Active Status bit

1 = Stack frame is active; W14 and W15 address 0x0000 to 0xFFFF, regardless of DSRPAG

0 = Stack frame is not active; W14 and W15 address the base Data Space

bit 1 RND: Rounding Mode Select bit

1 = Biased (conventional) rounding is enabled
 0 = Unbiased (convergent) rounding is enabled
 IF: Integer or Fractional Multiplier Mode Select bit

1 = Integer mode is enabled for DSP multiply0 = Fractional mode is enabled for DSP multiply

Note 1: This bit is always read as '0'.

2: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level.

REGISTER 3-3: CTXTSTAT: CPU W REGISTER CONTEXT STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	R-0	R-0	R-0
_	_	_	_	_	CCTXI2	CCTXI1	CCTXI0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R-0	R-0	R-0
_	_	_	_	_	MCTXI2	MCTXI1	MCTXI0
bit 7							bit 0

Legend:

bit 0

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-11 **Unimplemented:** Read as '0'

bit 10-8 CCTXI<2:0>: Current (W Register) Context Identifier bits

111 = Reserved

•

•

011 = Reserved

010 = Alternate Working Register Set 2 is currently in use

001 = Alternate Working Register Set 1 is currently in use

000 = Default register set is currently in use

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 MCTXI<2:0>: Manual (W Register) Context Identifier bits

111 = Reserved

•

•

011 = Reserved

010 = Alternate Working Register Set 2 was most recently manually selected

001 = Alternate Working Register Set 1 was most recently manually selected

000 = Default register set was most recently manually selected

TABLE 4-2: CPU CORE REGISTER MAP (CONTINUED)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
DOENDL	003E					D	o Loop End	Address Re	egister Low	(DOENDL<	:15:1>)						_	0000
DOENDH	0040	_	_	_	_	_	_	_	_	_	_	DO Lo	oop End Ad	dress Regi	ster High (I	OOENDH<	5:0>)	0000
SR	0042	OA	ОВ	SA	SB	OAB	SAB	DA	DC	IPL2	IPL1	IPL0	RA	N	OV	Z	С	0000
CORCON	0044	VAR	_	US1	US0	EDT	DL2	DL1	DL0	SATA	SATB	SATDW	ACCSAT	IPL3	SFA	RND	IF	0020
MODCON	0046	XMODEN	YMODEN	_	_	BWM3	BWM2	BWM1	BWM0	YWM3	YWM2	YWM1	YWM0	XWM3	XWM2	XWM1	XWM0	0000
XMODSRT	0048						X Mode Star	t Address F	Register (XN	/ODSRT<1	5:1>)						_	0000
XMODEND	004A						X Mode End	Address R	egister (XIV	IODEND<1	5:1>)						_	0001
YMODSRT	004C						Y Mode Star	t Address F	Register (YN	//ODSRT<1	5:1>)						_	0000
YMODEND	004E						Y Mode End	Address R	egister (YM	IODEND<1	5:1>)						_	0001
XBREV	0050	BREN							XBRE	V<14:0>								0000
DISICNT	0052	_	— — DISICNT<13:0>										0000					
TBLPAG	0054	_	_	_	_	_	_	_	_				TBLPAG	G<7:0>				0000
CTXTSTAT	005A	_	_	_	_	_	CCTXI2	CCTXI1	CCTXI0	_	_	_	_	_	MCTXI2	MCTXI1	MCTXI0	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: The contents of this register should never be modified. The DSWPAG must always point to the first page.

dsPIC33EPXXGS50X FAMILY

TABLE 4-3: INTERRUPT CONTROLLER REGISTER MAP (CONTINUED)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
IPC12	0858	_	_	_	_	_	MI2C2IP2	MI2C2IP1	MI2C2IP0	_	SI2C2IP2	SI2C2IP1	SI2C2IP0	_	_	_	_	0440
IPC13	085A	_	_	_	_	_	INT4IP2	INT4IP1	INT4IP0	I	1	1	1	_	1	_	1	0400
IPC14	085C	-	_	_	_	-	-	ı	-	ı	PSEMIP2	PSEMIP1	PSEMIP0	_	ı	_	1	0040
IPC16	0860	_	_	_	_	_	U2EIP2	U2EIP1	U2EIP0	-	U1EIP2	U1EIP1	U1EIP0	_	ı	_	-	0440
IPC18	0864	_	_	_	_	_	_	_	_	_	PSESIP2	PSESIP1	PSESIP0	_	-	_	_	0040
IPC23	086E		PWM2IP2	PWM2IP1	PWM2IP0		PWM1IP2	PWM1IP1	PWM1IP0	_	_	_	_	_	_	_	_	4400
IPC24	0870		_	_	_		PWM5IP2	PWM5IP1	PWM5IP0	_	PWM4IP2	PWM4IP1	PWM4IP0	_	PWM3IP2	PWM3IP1	PWM3IP0	0444
IPC25	0872	_	AC2IP2	AC2IP1	AC2IP0	_	_	_	_	-	_	_	-	_	-	_	_	4000
IPC26	0874		_	_	_		_	_	_	_	AC4IP2	AC4IP1	AC4IP0	_	AC3IP2	AC3IP1	AC3IP0	0044
IPC27	0876		ADCAN1IP2	ADCAN1IP1	ADCAN1IP0		ADCAN0IP2	ADCAN0IP1	ADCAN0IP0	_	_	_	_	_	_	_	_	4400
IPC28	0878		ADCAN5IP2	ADCAN5IP1	ADCAN5IP0		ADCAN4IP2	ADCAN4IP1	ADCAN4IP0	_	ADCAN3IP2	ADCAN3IP1	ADCAN3IP0	_	ADCAN2IP2	ADCAN2IP1	ADCAN2IP0	4444
IPC29	087A		_	_	_		_	_	_	_	ADCAN7IP2	ADCAN7IP1	ADCAN7IP0	_	ADCAN6IP2	ADCAN6IP1	ADCAN6IP0	0044
IPC35	0886		JTAGIP2	JTAGIP1	JTAGIP0		ICDIP2	ICDIP1	ICDIP0	_	_	_	_	_	_	_	_	4400
IPC37	088A	_	ADCAN8IP2 ⁽²⁾	ADCAN8IP1 ⁽²⁾	ADCAN8IP0 ⁽²⁾	_	_	_	_	-	_	_	-	_	-	_	_	4000
IPC38	088C		ADCAN12IP2 ⁽²⁾	ADCAN12IP1 ⁽²⁾	ADCAN12IP0 ⁽²⁾		ADCAN11IP2 ⁽²⁾	ADCAN11IP1 ⁽²⁾	ADCAN11IP0 ⁽²⁾	_	ADCAN10IP2 ⁽²⁾	ADCAN10IP1 ⁽²⁾	ADCAN10IP0 ⁽²⁾	_	ADCAN9IP2 ⁽²⁾	ADCAN9IP1 ⁽²⁾	ADCAN9IP0 ⁽²⁾	4444
IPC39	088E		ADCAN16IP2 ⁽¹⁾	ADCAN16IP1(1)	ADCAN16IP0 ⁽¹⁾		ADCAN15IP2 ⁽¹⁾	ADCAN15IP1 ⁽¹⁾	ADCAN15IP0 ⁽¹⁾	_	ADCAN14IP2 ⁽²⁾	ADCAN14IP1 ⁽²⁾	ADCAN14IP0 ⁽²⁾	_	ADCAN13IP2 ⁽¹⁾	ADCAN13IP1	ADCAN13IP0	4444
IPC40	0890		ADCAN20IP2	ADCAN20IP1	ADCAN20IP0		ADCAN19IP2	ADCAN19IP1	ADCAN19IP0	_	ADCAN18IP2	ADCAN18IP1	ADCAN18IP0	_	ADCAN17IP2 ⁽²⁾	ADCAN17IP1 ⁽²⁾	ADCAN17IP0 ⁽²⁾	4444
IPC41	0892		_	_	_		_	_	_	_	_	_	_	_	ADCAN21IP2	ADCAN21IP1	ADCAN21IP0	0004
IPC43	0896		_	_	_		I2C2BCIP2	I2C2BCIP1	I2C2BCIP0	_	I2C1BCIP2	I2C1BCIP1	I2C1BCIP0	_	_	_	_	0440
IPC44	0898		ADFLTR0IP2	ADFLTR0IP1	ADFLTR0IP0		ADCMP1IP2	ADCMP1IP1	ADCMP1IP0	_	ADCMP0IP2	ADCMP0IP1	ADCMP0IP0	_	_	_	_	4440
IPC45	089A		_	_	_	_	_	_	_	_	_	_	_	_	ADFLTR1IP2	ADFLTR1IP1	ADFLTR1IP0	0004
INTCON1	08C0	NSTDIS	OVAERR	OVBERR	COVAERR	COVBERR	OVATE	OVBTE	COVTE	SFTACERR	DIV0ERR	_	MATHERR	ADDRERR	STKERR	OSCFAIL	_	0000
INTCON2	08C2	GIE	DISI	SWTRAP	_	_	_	_	AIVTEN	_	_	_	INT4EP	_	INT2EP	INT1EP	INT0EP	8000
INTCON3	08C4	_	_	_	_	_	-	-	NAE	-	-	-	DOOVR	_	1	_	APLL	0000
INTCON4	08C6		_	_	_	_	_	_	_	_	_	_	_	_	_	_	SGHT	0000
INTTREG	08C8	_	_	_	_	ILR3	ILR2	ILR1	ILR0	VECNUM7	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0	0000

— = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Only available on dsPIC33EPXXGS506 devices.

Only available on dsPIC33EPXXGS504/505 and dsPIC33EPXXGS506 devices.

TABLE 4-20: PERIPHERAL PIN SELECT INPUT REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPINR0	06A0				INT1R	R<7:0>				_	_	_	_	_	_	_	_	0000
RPINR1	06A2	_	_	_	_	_	_	_	_				INT2I	R<7:0>				0000
RPINR2	06A4				T1CKF	R<7:0>				_	-	_	_	_	ı	-	_	0000
RPINR3	06A6	T3CKR7	T3CKR6	T3CKR5	T3CKR4	T3CKR3	T3CKR2	T3CKR1	T3CKR0	T2CKR7	T2CKR6	T2CKR5	T2CKR4	T2CKR3	T2CKR2	T2CKR1	T2CKR0	0000
RPINR7	06AE	IC2R7	IC2R6	IC2R5	IC2R4	IC2R3	IC2R2	IC2R1	IC2R0	IC1R7	IC1R6	IC1R5	IC1R4	IC1R3	IC1R2	IC1R1	IC1R0	0000
RPINR8	06B0	IC4R7	IC4R6	IC4R5	IC4R4	IC4R3	IC4R2	IC4R1	IC4R0	IC3R7	IC3R6	IC3R5	IC3R4	IC3R3	IC3R2	IC3R1	IC3R0	0000
RPINR11	06B6		ı	-	-	ı	ı	-	_				OCFA	R<7:0>				0000
RPINR12	06B8	FLT2R7	FLT2R6	FLT2R5	FLT2R4	FLT2R3	FLT2R2	FLT2R1	FLT2R0	FLT1R7	FLT1R6	FLT1R5	FLT1R4	FLT1R3	FLT1R2	FLT1R1	FLT1R0	0000
RPINR13	06BA	FLT4R7	FLT4R6	FLT4R5	FLT4R4	FLT4R3	FLT4R2	FLT4R1	FLT4R0	FLT3R7	FLT3R6	FLT3R5	FLT3R4	FLT3R3	FLT3R2	FLT3R1	FLT3R0	0000
RPINR18	06C4	U1CTSR7	U1CTSR6	U1CTSR5	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTS0	U1RXR7	U1RXR6	U1RXR5	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0	0000
RPINR19	06C6	U2CTSR7	U2CTSR6	U2CTSR5	U2CTSR4	U2CTSR3	U2CTSR2	U2CTSR1	U2CTSR0	U2RXR7	U2RXR6	U2RXR5	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0	0000
RPINR20	06C8	SCK1INR7	SCK1INR6	SCK1INR5	SCK1INR4	SCK1INR3	SCK1INR2	SCK1INR1	SCK1INR0	SDI1R7	SDI1R6	SDI1R5	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0	0000
RPINR21	06CA	-	-	_	_	-	_	_	-				SS1F	R<7:0>				0000
RPINR22	06CC	SCK2INR7	SCK2INR6	SCK2INR5	SCK2INR4	SCK2INR3	SCK2INR2	SCK2INR1	SCK2INR0	SDI2R7	SDI2R6	SDI2R5	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0	0000
RPINR23	06CE	-	-	_	_	-	_	_	-				SS2F	R<7:0>				0000
RPINR37	06EA				SYNCI1	R<7:0>				1	-	-	_	_	_	-	_	0000
RPINR38	06EC	_	-	-		_	-	_	_				SYNCI	2R<7:0>				0000
RPINR42	06F4	FLT6R7	FLT6R6	FLT6R5	FLT6R4	FLT6R3	FLT6R2	FLT6R1	FLT6R0	FLT5R7	FLT5R6	FLT5R5	FLT5R4	FLT5R3	FLT5R2	FLT5R1	FLT5R0	0000
RPINR43	06F6	FLT8R7	FLT8R6	FLT8R5	FLT8R4	FLT8R3	FLT8R2	FLT8R1	FLT8R0	FLT7R7	FLT7R6	FLT7R5	FLT7R4	FLT7R3	FLT7R2	FLT7R1	FLT7R0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

10.0 I/O PORTS

Note 1: This data sheet summarizes the features of the dsPIC33EPXXGS50X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "I/O Ports" (DS70000598) in the "dsPIC33/PIC24 Family Reference Manual", which is available from the Microchip web site (www.microchip.com).

> 2: Some registers and associated bits described in this section may not be available on all devices. Refer to Section 4.0 "Memory Organization" in this data sheet for device-specific register and bit information.

Many of the device pins are shared among the peripherals and the Parallel I/O ports. All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

Parallel I/O (PIO) Ports 10.1

Generally, a Parallel I/O port that shares a pin with a peripheral is subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of

the I/O pin. The logic also prevents "loop through", in which a port's digital output can drive the input of a peripheral that shares the same pin. Figure 10-1 illustrates how ports are shared with other peripherals and the associated I/O pin to which they are connected.

When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin can be read, but the output driver for the parallel port bit is disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin can be driven by a port.

All port pins have eight registers directly associated with their operation as digital I/Os. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx), read the latch. Writes to the latch, write the latch. Reads from the port (PORTx), read the port pins, while writes to the port pins, write the latch.

Any bit and its associated data and control registers that are not valid for a particular device are disabled. This means the corresponding LATx and TRISx registers, and the port pin are read as zeros.

When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless regarded as a dedicated port because there is no other competing source of outputs.

Peripheral Module Output Multiplexers Peripheral Input Data Peripheral Module Enable I/O Peripheral Output Enable Output Enable Peripheral Output Data **PIO Module** Output Data Read TRISx Data Bus D Q I/O Pin WR TRISX CK L TRISx Latch D Q WR LATx + CK 🔻 WR PORTX Data Latch Read LATx Input Data Read PORTx

FIGURE 10-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE

TABLE 10-1: SELECTABLE INPUT SOURCES (MAPS INPUT TO FUNCTION)

Input Name ⁽¹⁾	Function Name	Register	Configuration Bits
External Interrupt 1	INT1	RPINR0	INT1R<7:0>
External Interrupt 2	INT2	RPINR1	INT2R<7:0>
Timer1 External Clock	T1CK	RPINR2	T1CKR<7:0>
Timer2 External Clock	T2CK	RPINR3	T2CKR<7:0>
Timer3 External Clock	T3CK	RPINR3	T3CKR<7:0>
Input Capture 1	IC1	RPINR7	IC1R<7:0>
Input Capture 2	IC2	RPINR7	IC2R<7:0>
Input Capture 3	IC3	RPINR8	IC3R<7:0>
Input Capture 4	IC4	RPINR8	IC4R<7:0>
Output Compare Fault A	OCFA	RPINR11	OCFAR<7:0>
PWM Fault 1	FLT1	RPINR12	FLT1R<7:0>
PWM Fault 2	FLT2	RPINR12	FLT2R<7:0>
PWM Fault 3	FLT3	RPINR13	FLT3R<7:0>
PWM Fault 4	FLT4	RPINR13	FLT4R<7:0>
UART1 Receive	U1RX	RPINR18	U1RXR<7:0>
UART1 Clear-to-Send	U1CTS	RPINR18	U1CTSR<7:0>
UART2 Receive	U2RX	RPINR19	U2RXR<7:0>
UART2 Clear-to-Send	U2CTS	RPINR19	U2CTSR<7:0>
SPI1 Data Input	SDI1	RPINR20	SDI1R<7:0>
SPI1 Clock Input	SCK1	RPINR20	SCK1R<7:0>
SPI1 Slave Select	SS1	RPINR21	SS1R<7:0>
SPI2 Data Input	SDI2	RPINR22	SDI2R<7:0>
SPI2 Clock Input	SCK2	RPINR22	SCK2R<7:0>
SPI2 Slave Select	SS2	RPINR23	SS2R<7:0>
PWM Synch Input 1	SYNCI1	RPINR37	SYNCI1R<7:0>
PWM Synch Input 2	SYNCI2	RPINR38	SYNCI2R<7:0>
PWM Fault 5	FLT5	RPINR42	FLT5R<7:0>
PWM Fault 6	FLT6	RPINR42	FLT6R<7:0>
PWM Fault 7	FLT7	RPINR43	FLT7R<7:0>
PWM Fault 8	FLT8	RPINR43	FLT8R<7:0>

Note 1: Unless otherwise noted, all inputs use the Schmitt Trigger input buffers.

10.5 I/O Helpful Tips

- 1. In some cases, certain pins, as defined in Table 26-11 under "Injection Current", have internal protection diodes to VDD and Vss. The term, "Injection Current", is also referred to as "Clamp Current". On designated pins, with sufficient external current-limiting precautions by the user, I/O pin input voltages are allowed to be greater or less than the data sheet absolute maximum ratings, with respect to the Vss and VDD supplies. Note that when the user application forward biases either of the high or low side internal input clamp diodes, that the resulting current being injected into the device, that is clamped internally by the VDD and Vss power rails, may affect the ADC accuracy by four to six counts.
- 2. I/O pins that are shared with any analog input pin (i.e., ANx) are always analog pins by default after any Reset. Consequently, configuring a pin as an analog input pin automatically disables the digital input pin buffer and any attempt to read the digital input level by reading PORTx or LATx will always return a '0', regardless of the digital logic level on the pin. To use a pin as a digital I/O pin on a shared ANx pin, the user application needs to configure the Analog Pin Configuration registers in the I/O ports module (i.e., ANSELx) by setting the appropriate bit that corresponds to that I/O port pin to a '0'.

Note: Although it is not possible to use a digital input pin when its analog function is enabled, it is possible to use the digital I/O output function, TRISx = 0x0, while the analog function is also enabled. However, this is not recommended, particularly if the analog input is connected to an external analog voltage source, which would create signal contention between the analog signal and the output pin driver.

- 3. Most I/O pins have multiple functions. Referring to the device pin diagrams in this data sheet, the priorities of the functions allocated to any pins are indicated by reading the pin name from left-to-right. The left most function name takes precedence over any function to its right in the naming convention. For example: AN16/T2CK/T7CK/RC1; this indicates that AN16 is the highest priority in this example and will supersede all other functions to its right in the list. Those other functions to its right, even if enabled, would not work as long as any other function to its left was enabled. This rule applies to all of the functions listed for a given pin.
- 4. Each pin has an internal weak pull-up resistor and pull-down resistor that can be configured using the CNPUx and CNPDx registers, respectively. These resistors eliminate the need for external resistors in certain applications. The internal pull-up is up to ~(VDD 0.8), not VDD. This value is still above the minimum VIH of CMOS and TTL devices.
- 5. When driving LEDs directly, the I/O pin can source or sink more current than what is specified in the VOH/IOH and VOL/IOL DC characteristics specification. The respective IOH and IOL current rating only applies to maintaining the corresponding output at or above the VOH, and at or below the VOL levels. However, for LEDs, unlike digital inputs of an externally connected device, they are not governed by the same minimum VIH/VIL levels. An I/O pin output can safely sink or source any current less than that listed in the Absolute Maximum Ratings in Section 26.0 "Electrical Characteristics" of this data sheet. For example:

VOH = 2.4v @ IOH = -8 mA and VDD = 3.3VThe maximum output current sourced by any 8 mA I/O pin = 12 mA.

LED source current < 12 mA is technically permitted. Refer to the VOH/IOH graphs in **Section 27.0 "DC and AC Device Characteristics Graphs"** for additional information.

REGISTER 10-12: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

| R/W-0 |
|----------|----------|----------|----------|----------|----------|----------|----------|
| SCK1INR7 | SCK1INR6 | SCK1INR5 | SCK1INR4 | SCK1INR3 | SCK1INR2 | SCK1INR1 | SCK1INR0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 |
|--------|--------|--------|--------|--------|--------|--------|--------|
| SDI1R7 | SDI1R6 | SDI1R5 | SDI1R4 | SDI1R3 | SDI1R2 | SDI1R1 | SDI1R0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 SCK1INR<7:0>: Assign SPI1 Clock Input (SCK1) to the Corresponding RPn Pin bits

10110101 = Input tied to RP181 10110100 = Input tied to RP180

•

•

00000001 = Input tied to RP1 00000000 = Input tied to Vss

bit 7-0 SDI1R<7:0>: Assign SPI1 Data Input (SDI1) to the Corresponding RPn Pin bits

10110101 = Input tied to RP181 10110100 = Input tied to RP180

•

.

00000001 = Input tied to RP1 00000000 = Input tied to Vss

REGISTER 10-16: RPINR37: PERIPHERAL PIN SELECT INPUT REGISTER 37

| R/W-0 |
|----------|----------|----------|----------|----------|----------|----------|----------|
| SYNCI1R7 | SYNCI1R6 | SYNCI1R5 | SYNCI1R4 | SYNCI1R3 | SYNCI1R2 | SYNCI1R1 | SYNCI1R0 |
| bit 15 | | | | | | | bit 8 |

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 SYNCI1R<7:0>: Assign PWM Synchronization Input 1 to the Corresponding RPn Pin bits

> 10110101 = Input tied to RP181 10110100 = Input tied to RP180

00000001 = Input tied to RP1 00000000 = Input tied to Vss

bit 7-0 Unimplemented: Read as '0'

REGISTER 10-36: RPOR16: PERIPHERAL PIN SELECT OUTPUT REGISTER 16

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP177R5	RP177R4	RP177R3	RP177R2	RP177R1	RP177R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP176R5	RP176R4	RP176R3	RP176R2	RP176R1	RP176R0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 RP177R<5:0>: Peripheral Output Function is Assigned to RP177 Output Pin bits

(see Table 10-2 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 RP176R<5:0>: Peripheral Output Function is Assigned to RP176 Output Pin bits

(see Table 10-2 for peripheral function numbers)

REGISTER 10-37: RPOR17: PERIPHERAL PIN SELECT OUTPUT REGISTER 17

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP179R5	RP179R4	RP179R3	RP179R2	RP179R1	RP179R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	RP178R5	RP178R4	RP178R3	RP178R2	RP178R1	RP178R0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 RP179R<5:0>: Peripheral Output Function is Assigned to RP179 Output Pin bits

(see Table 10-2 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 RP178R<5:0>: Peripheral Output Function is Assigned to RP178 Output Pin bits

(see Table 10-2 for peripheral function numbers)

REGISTER 15-3: PTPER: PWMx PRIMARY MASTER TIME BASE PERIOD REGISTER (1,2)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
PTPER<15:8>								
bit 15							bit 8	

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0
			PTPE	R<7:0>			
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 PTPER<15:0>: Primary Master Time Base (PMTMR) Period Value bits

Note 1: The PWMx time base has a minimum value of 0x0010 and a maximum value of 0xFFF8.

2: Any period value that is less than 0x0028 must have the Least Significant 3 bits set to '0', thus yielding a period resolution at 8.32 ns (at fastest auxiliary clock rate).

REGISTER 15-4: SEVTCMP: PWMx SPECIAL EVENT COMPARE REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SEVTCMP<12:5>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
	S	SEVTCMP<4:0>	>		_	_	_
bit 7					bit 0		

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-3 **SEVTCMP<12:0>:** Special Event Compare Count Value bits

bit 2-0 **Unimplemented:** Read as '0'

Note 1: One LSB = 1.04 ns (at fastest auxiliary clock rate); therefore, the minimum SEVTCMP resolution is 8.32 ns.

REGISTER 19-2: ADCON1H: ADC CONTROL REGISTER 1 HIGH

r-0	r-0	r-0	r-0	r-0	r-0	r-0	r-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-1	R/W-1	r-0	r-0	r-0	r-0	r-0
FORM	SHRRES1	SHRRES0	_	_	_	_	_
bit 7							bit 0

Legend: r = Reserved bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Reserved:** Maintain as '0'

bit 7 FORM: Fractional Data Output Format bit

1 = Fractional0 = Integer

bit 6-5 SHRRES<1:0>: Shared ADC Core Resolution Selection bits

11 = 12-bit resolution 10 = 10-bit resolution 01 = 8-bit resolution 00 = 6-bit resolution

bit 4-0 Reserved: Maintain as '0'

REGISTER 20-1: CMPxCON: COMPARATOR x CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CMPON	_	CMPSIDL	HYSSEL1	HYSSEL0	FLTREN	FCLKSEL	DACOE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	HC-0, HS	R/W-0	R/W-0	R/W-0
INSEL1	INSEL0	EXTREF	HYSPOL	CMPSTAT	ALTINP	CMPPOL	RANGE
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	it HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15 CMPON: Comparator Operating Mode bit

1 = Comparator module is enabled

0 = Comparator module is disabled (reduces power consumption)

bit 14 Unimplemented: Read as '0'

bit 13 CMPSIDL: Comparator Stop in Idle Mode bit

1 = Discontinues module operation when device enters Idle mode.

0 = Continues module operation in Idle mode

If a device has multiple comparators, any CMPSIDL bit set to '1' disables all comparators while in Idle mode.

bit 12-11 **HYSSEL<1:0>:** Comparator Hysteresis Select bits

11 = 20 mV hysteresis

10 = 10 mV hysteresis

01 = 5 mV hysteresis

00 = No hysteresis is selected

bit 10 FLTREN: Digital Filter Enable bit

1 = Digital filter is enabled

0 = Digital filter is disabled

bit 9 FCLKSEL: Digital Filter and Pulse Stretcher Clock Select bit

1 = Digital filter and pulse stretcher operate with the PWM clock

0 = Digital filter and pulse stretcher operate with the system clock

bit 8 DACOE: DACx Output Enable bit

1 = DACx analog voltage is connected to the DACOUTx pin⁽¹⁾

0 = DACx analog voltage is not connected to the DACOUTx pin

bit 7-6 **INSEL<1:0>:** Input Source Select for Comparator bits

If ALTINP = 0, Select from Comparator Inputs:

11 = Selects CMPxD input pin

10 = Selects CMPxC input pin

01 = Selects CMPxB input pin

00 = Selects CMPxA input pin

If ALTINP = 1, Select from Alternate Inputs:

11 = Reserved

10 = Reserved

01 = Selects PGA2 output

00 = Selects PGA1 output

Note 1: DACOUTx can be associated only with a single comparator at any given time. The software must ensure that multiple comparators do not enable the DACx output by setting their respective DACOE bit.

REGISTER 21-1: PGAxCON: PGAx CONTROL REGISTER (CONTINUED)

bit 2-0 GAIN<2:0>: PGAx Gain Selection bits

111 = Reserved 110 = Gain of 64x 101 = Gain of 32x 100 = Gain of 16x

011 = Gain of 8x 010 = Gain of 4x 001 = Reserved 000 = Reserved

REGISTER 21-2: PGAxCAL: PGAx CALIBRATION REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
_	_		PGACAL<5:0>								
bit 7							bit 0				

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-6 **Unimplemented:** Read as '0'

bit 5-0 **PGACAL<5:0>:** PGAx Offset Calibration bits

The calibration values for PGA1 and PGA2 must be copied from Flash addresses, 0x800E48 and 0x800E4C, respectively, into these bits before the module is enabled. Refer to the calibration data address table (Table 23-3) in **Section 23.0 "Special Features"** for more information.

23.2 Device Calibration and Identification

The PGAx and current source modules on the dsPIC33EPXXGS50X family devices require Calibration Data registers to improve performance of the module over a wide operating range. These Calibration registers are read-only and are stored in configuration memory space. Prior to enabling the module, the calibration data must be read (TBLPAG and Table Read instruction) and loaded into its respective SFR registers. The device calibration addresses are shown in Table 23-3.

The dsPIC33EPXXGS50X devices have two identification registers near the end of configuration memory space that store the Device ID (DEVID) and Device Revision (DEVREV). These registers are used to determine the mask, variant and manufacturing information about the device. These registers are read-only and are shown in Register 23-1 and Register 23-2.

TABLE 23-3: DEVICE CALIBRATION ADDRESSES⁽¹⁾

Calibration Name	Address	Bits 23-16	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PGA1CAL	800E48	_	_	_	_	_	_	_	_	_	_	_	PGA1 Calibration Data					
PGA2CAL	800E4C			_	_	_	_	_		_		_	PGA2 Calibration Data					
													1 0/12 Cambration Bata					
ISRCCAL	800E78	_	_	_	_	_	_	_	_	_	_	_	Current Source Calibration Data		ata			

Note 1: The calibration data must be copied into its respective registers prior to enabling the module.

23.7 JTAG Interface

The dsPIC33EPXXGS50X family devices implement a JTAG interface, which supports boundary scan device testing. Detailed information on this interface is provided in future revisions of the document.

Note: Refer to "Programming and Diagnostics" (DS70608) in the "dsPIC33/PIC24 Family Reference Manual" for further information on usage, configuration and operation of the JTAG interface.

23.8 In-Circuit Serial Programming™

The dsPIC33EPXXGS50X family devices can be serially programmed while in the end application circuit. This is done with two lines for clock and data, and three other lines for power, ground and the programming sequence. Serial programming allows customers to manufacture boards with unprogrammed devices and then program the device just before shipping the product. Serial programming also allows the most recent firmware or a custom firmware to be programmed. Refer to the "dsPIC33E/PIC24E Flash Programming Specification for Devices with Volatile Configuration Bits" (DS70663) for details about In-Circuit Serial Programming™ (ICSP™).

Any of the three pairs of programming clock/data pins can be used:

- PGEC1 and PGED1
- PGEC2 and PGED2
- · PGEC3 and PGED3

23.9 In-Circuit Debugger

When MPLAB[®] ICD 3 or REAL ICE™ emulator is selected as a debugger, the in-circuit debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. Debugging functionality is controlled through the PGECx (Emulation/Debug Clock) and PGEDx (Emulation/Debug Data) pin functions.

Any of the three pairs of debugging clock/data pins can be used:

- PGEC1 and PGED1
- PGEC2 and PGED2
- PGEC3 and PGED3

To use the in-circuit debugger function of the device, the design must implement ICSP connections to MCLR, VDD, Vss and the PGECx/PGEDx pin pair. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins (PGECx and PGEDx).

23.10 Code Protection and CodeGuard™ Security

dsPIC33EPXXGS50X devices offer multiple levels of security for protecting individual intellectual property. The program Flash protection can be broken up into three segments: Boot Segment (BS), General Segment (GS) and Configuration Segment (CS). Boot Segment has the highest security privilege and can be thought to have limited restrictions when accessing other segments. General Segment has the least security and is intended for the end user system code. Configuration Segment contains only the device user configuration data which is located at the end of the program memory space.

The code protection features are controlled by the Configuration registers, FSEC and FBSLIM. The FSEC register controls the code-protect level for each segment and if that segment is write-protected. The size of BS and GS will depend on the BSLIM<12:0> setting and if the Alternate Interrupt Vector Table (AIVT) is enabled. The BSLIM<12:0> bits define the number of pages for BS with each page containing 512 IW. The smallest BS size is one page, which will consist of the Interrupt Vector Table (IVT) and 256 IW of code protection.

If the AIVT is enabled, the last page of BS will contain the AIVT and will not contain any BS code. With AIVT enabled, the smallest BS size is now two pages (1024 IW), with one page for the IVT and BS code, and the other page for the AIVT. Write protection of the BS does not cover the AIVT. The last page of BS can always be programmed or erased by BS code. The General Segment will start at the next page and will consume the rest of program Flash except for the Flash Configuration Words. The IVT will assume GS security only if BS is not enabled. The IVT is protected from being programmed or page erased when either security segment has enabled write protection.

Note: Refer to "CodeGuard™ Intermediate Security" (DS70005182) in the "dsPIC33/PIC24 Family Reference Manual" for further information on usage, configuration and operation of CodeGuard Security.

TABLE 26-8: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

DC CHARACT	ERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended						
Parameter No.	Тур.	Max.	Units	Units Conditions					
Power-Down Current (IPD) ⁽¹⁾									
DC60d	12	100	μА	-40°C					
DC60a	18	100	μА	+25°C	3.3V				
DC60b	130	400	μА	+85°C	3.30				
DC60c 500 1100			μА	+125°C					

Note 1: IPD (Sleep) current is measured as follows:

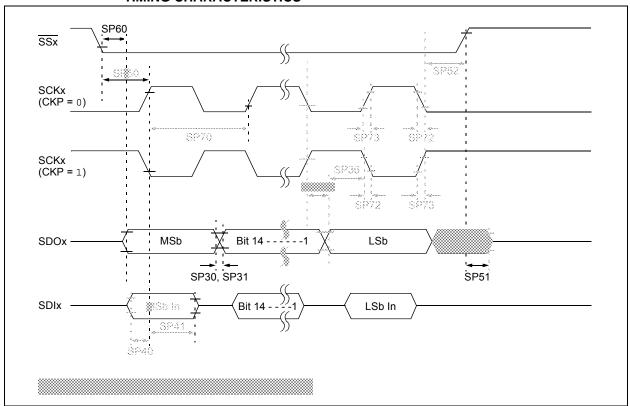
- CPU core is off, oscillator is configured in EC mode and external clock is active; OSC1 is driven with external square wave from rail-to-rail (EC clock overshoot/undershoot < 250 mV required)
- · CLKO is configured as an I/O input pin in the Configuration Word
- · All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD, WDT and FSCM are disabled
- All peripheral modules are disabled (PMDx bits are all set)
- The VREGS bit (RCON<8>) = 0 (i.e., core regulator is set to standby while the device is in Sleep mode)
- The VREGSF bit (RCON<11>) = 0 (i.e., Flash regulator is set to standby while the device is in Sleep mode)
- · JTAG is disabled

TABLE 26-9: DC CHARACTERISTICS: WATCHDOG TIMER DELTA CURRENT (△IWDT)⁽¹⁾

DC CHARACTER	ISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended					
Parameter No.	Тур.	Max.	Units	s Conditions				
DC61d	13	50	μΑ	-40°C				
DC61a	19	80	μΑ	+25°C	3.3V			
DC61b	12	_	μΑ	+85°C	3.3V			
DC61c	13	_	μΑ	+125°C				

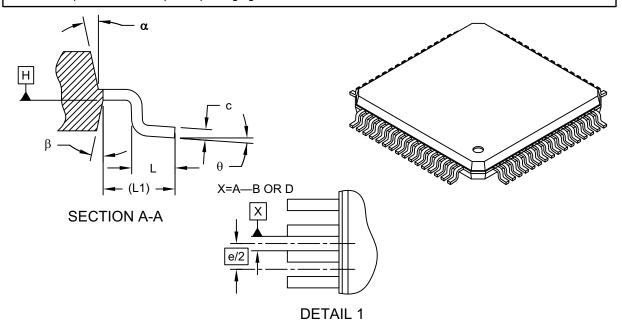
Note 1: The ΔIWDT current is the additional current consumed when the module is enabled. This current should be added to the base IPD current. All parameters are characterized but not tested during manufacturing.

FIGURE 26-16: SPIX SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0) TIMING CHARACTERISTICS



64-Lead Plastic Thin Quad Flatpack (PT)-10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS						
Dimension	MIN	NOM	MAX				
Number of Leads	N		64				
Lead Pitch	е		0.50 BSC				
Overall Height	Α	-	1.20				
Molded Package Thickness	A2	0.95	1.00	1.05			
Standoff	A1	0.05	0.05 -				
Foot Length	L	0.45	0.60	0.75			
Footprint	L1	1.00 REF					
Foot Angle	ф	0°	3.5°	7°			
Overall Width	Е	12.00 BSC					
Overall Length	D	12.00 BSC					
Molded Package Width	E1	10.00 BSC					
Molded Package Length	D1	10.00 BSC					
Lead Thickness	С	0.09	-	0.20			
Lead Width	b	0.17	0.22	0.27			
Mold Draft Angle Top	α	11°	12°	13°			
Mold Draft Angle Bottom	β	11°	12°	13°			

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085C Sheet 2 of 2

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- · Distributor or Representative
- · Local Sales Office
- Field Application Engineer (FAE)
- · Technical Support

Customers should contact their distributor, representative or Field Application Engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support